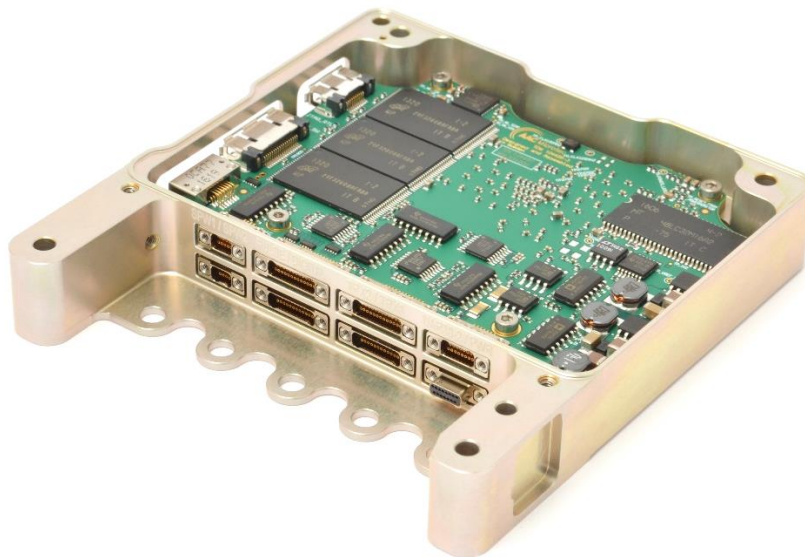


ICD – Sirius TCM

I



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Revision log

Rev	Date	Change description
A	2017-01-12	Released version
B	2017-10-03	Released version
C	2017-11-28	Released version
D	2018-06-21	Released version D with the following updates: - Figure 2, mechanical hole dimension added - Added TC and TM timing diagrams - Clarifications on I/O specifications
E	2019-06-05	Update of SpaceWire connector pinout
F	2020-11-26	Add information on screws and torques. Minor update of power input interface diagram
G	2022-05-04	Corrected terminations in UART interface diagrams, Added frequency plan and picture of inrush current, Update of structure and figures, Corrections of interface specs, differential GPIOs, frequency plan update
H	2023-06-19	Correcting GPIO complementary outputs, updating grounding section, minor updates
I	2025-04-02	Minor updates to Mechanics, correction in DEBUG-SW connector

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1. Introduction

This ICD is written for electrical and mechanical engineers using the AAC Sirius products. For software interface descriptions please see the Sirius Product User Manual document [RD1].

1.1. Reference documents

RD#	Document ref	Document name
RD1	205065	Sirius Product User Manual
RD2	104438	TCM-S Product step file

1.2. Acronyms and abbreviations

Acronym	Description
AAC CS	AAC Clyde Space
ADC	Analog to Digital Converter
CoM	Center of Mass
FPGA	Field-Programmable Gate Array
GPIO	General Purpose Input/Output
ICD	Interface Control Document
MEMS	Microelectromechanical systems
Mol	Moment of Inertia
LVDS	Low-voltage differential signaling
LVTTL	Low-voltage Transistor-Transistor Logic
OBC	On Board Computer
PPS	Pulse Per Second
PSU	Power Supply Unit
SpW	SpaceWire
TBD	To Be Defined
TCM	TT&C Control Module
TIM	Thermal Interface Material
UART	Universal Asynchronous Receiver/Transmitter

2. Mechanical ICD

2.1. General

All products in the Sirius AAC CS product family share the same formfactor of the enclosure, made from aluminum. The mechanical enclosure is designed to be configured as a stack that fits within the form factor of the CubeSat (PC104) standard. The Sirius TCM step file [RD2] provides a detailed representation of the mechanical form factor.

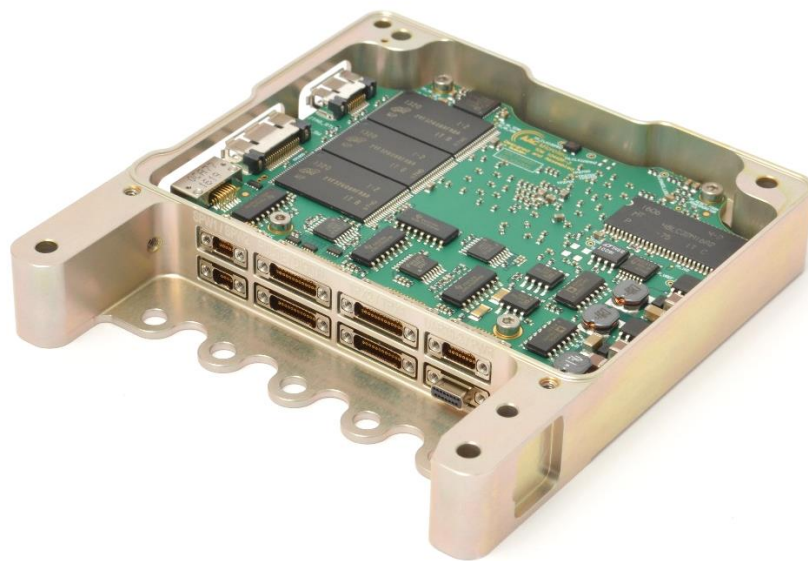


Figure 2.1 The Sirius TCM product without a lid.

2.2. Physical properties

PROPERTY	COMMENT	VALUE
MASS	Including lid	128 g
VOLUME	Space occupied by the enclosure	46 cm ³

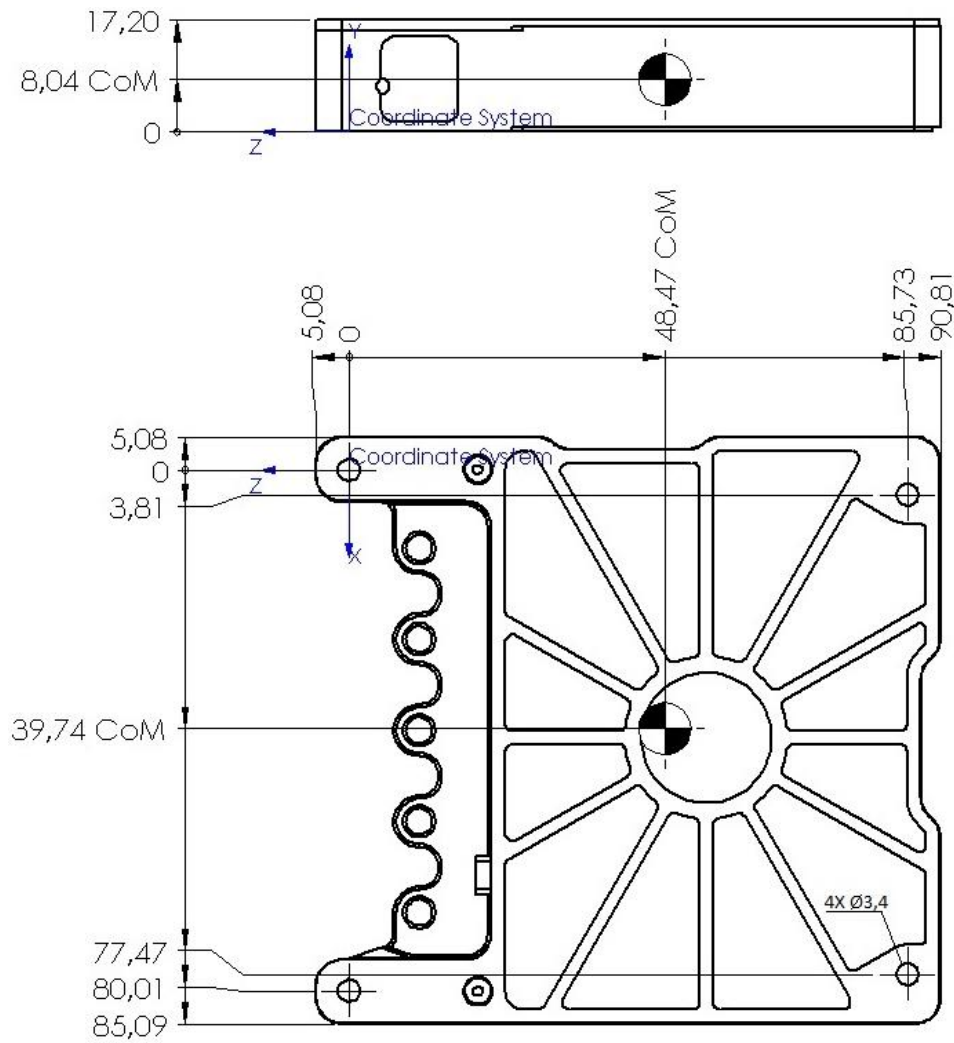


Figure 2.2 The dimensions of the Sirius TCM product, all measurements in mm.

2.3. Center of Mass

The center of mass (CoM) is identified in Figure 2.2 with the origin and direction of the output coordinate system (OCS) indicated by the blue text. Numbers are calculated based on SolidWorks CAD model.

AXIS	CENTER OF MASS WITH RESPECT TO THE OUTPUT COORDINATE SYSTEM
X	40 mm
Y	8 mm
Z	-49 mm

2.4. Moment of inertia and other mechanical data

As the Sirius TCM is typically provided in a combined data handling system, mechanical parameters are highly configuration dependent. These are therefore available on request.

2.5. Thermal dissipation

The primary thermal interface area of the unit is the flat surface on the +x face of the unit as shown in Figure 2.2 and marked blue in Figure 2.3. The maximum allowed temperature at the thermal interface is 60 °C, this figure is what has been used for design analysis and exceeding it will violate component derating rules. The size of the thermal interface area is 1 206 mm².

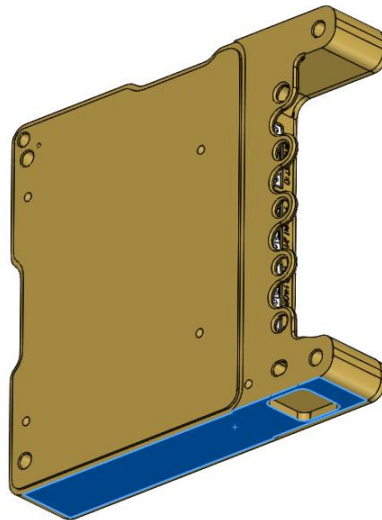


Figure 2.3 The Sirius TCM product thermal interface.

To aid in thermal transfer between the Sirius TCM and the surface to which it is mounted, a thermal interface pad is recommended to be placed between Sirius TCM and the spacecraft structure. The recommended TIM is Parker Cho-Therm 1671 or Laird Technology TGON 800. If an electrically insulating material is used, it is necessary to tie the structure to ground using the ground bonding point on the enclosure as described in Section 3.3.

2.6. Screws and torques

The debug hatch on the Sirius TCM is held in place with countersunk M2×6, A4-70 screws. The unit is delivered with the debug hatch fitted for transport purposes, but screws are not torqued nor secured for flight. It is the customer's responsibility, as part of the system integration process, to torque these screws to 0.25 Nm and apply staking glue when no further access to debug interface is needed. Figure 2.4 shows the location of the debug hatch screws (a DHS including OBC and TCM is shown).



Figure 2.4 Countersunk screws for debug hatch covering the JTAG and Debug connectors.

2.7. Surface Treatment

The mechanical parts are surface treated with SurTec 650A, providing corrosion resistance and electrical surface conductivity.

3. Electrical ICD

3.1. Connector locations pinout

Figure 3.1 illustrates the locations of all Sirius TCM connectors.

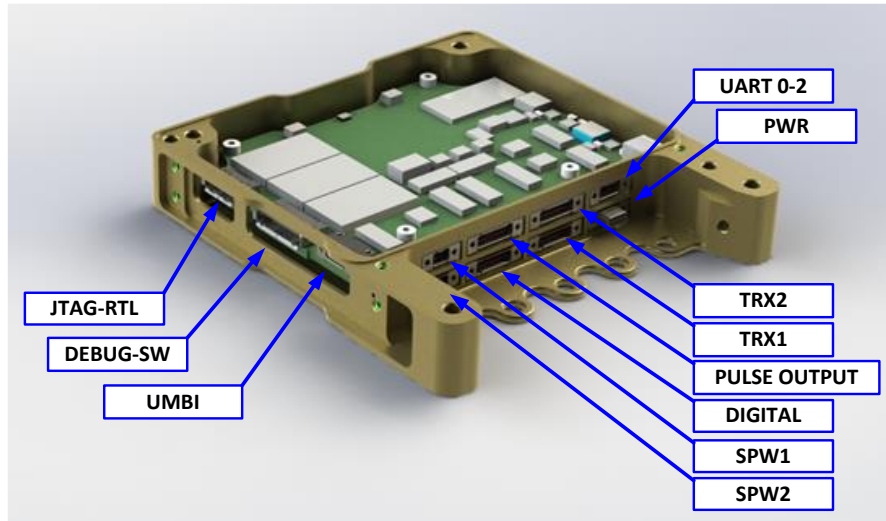


Figure 3.1 The connectors of the Sirius TCM product

3.1.1. PWR connector

This connector provides the input power for the unit, as well as PPS interfaces, pulse commands and safe mode communication interfaces.

nanoD15 Plug Connector		
PIN #	SIGNAL NAME	DESCRIPTION
1	VBUS+	Power input, positive
2	VBUS+	
3	UART7_RXTX_RS485_P	UART7 ⁽¹⁾ (RS485)
4	UART7_RXTX_RS485_N	
5	PPS_RS422_P	PPS transceiver (in/out)
6	PPS_RS422_N	
7	UART6_RXTX_RS485_P	UART6 ⁽²⁾ (RS485)
8	UART6_RXTX_RS485_N	
9	GND	Power return, signal/power ground
10	GND	
11	GND	
12	PULSE0_I_RS422_P	Pulse Command 0
13	PULSE0_I_RS422_N	
14	PULSE1_I_RS422_P	Pulse Command 1
15	PULSE1_I_RS422_N	

Note 1: legacy name “SAFEBUS”.

Note 2: legacy name “PSU control”.

3.1.2. UART0–2 connector

This connector provides three independent UART interfaces, each configurable to operate either in RS422 or RS485 mode (full- and half-duplex). To configure an interface for RS485 mode operation connect respective UARTx_RX_P pin to UARTx_TX_P and UARTx_RX_N pin to UARTx_TX_N.

nanoD15 Socket Connector		
PIN #	SIGNAL NAME	DESCRIPTION
1	UART0_RX_P	UART0 receive
2	UART0_RX_N	
3	UART0_TX_P	UART0 transmit
4	UART0_TX_N	
5	GND	Reference potential, signal/power ground
6	GND	
7	UART1_RX_P	UART1 receive
8	UART1_RX_N	
9	UART1_TX_P	UART1 transmit
10	UART1_TX_N	
11	UART2_RX_P	UART2 receive
12	UART2_RX_N	
13	UART2_TX_P	UART2 transmit
14	UART2_TX_N	
15	GND	Reference potential, signal/power ground

3.1.3. DIGITAL connector

This connector provides several digital I/O interfaces and an external interface for a PPS time synchronization signal.

Each two GPIO signals can be alternatively configured to work in pair as complementary differential outputs. This configuration affects control logic only, signaling levels remain same (LVTTTL) in both single and differential mode.

nanoD25 Socket Connector		
PIN #	SIGNAL NAME	DESCRIPTION
1	GPIO 0	LVTTTL digital input/output
2	GPIO 1	LVTTTL digital input/output, <i>alt. configuration: complementary LVTTTL output to GPIO0</i>
3	GPIO 2	LVTTTL digital input/output
4	GPIO 3	LVTTTL digital input/output, <i>alt. configuration: complementary LVTTTL output to GPIO2</i>
5	GPIO 4	LVTTTL digital input/output
6	GPIO 5	LVTTTL digital input/output <i>alt. configuration: complementary LVTTTL output to GPIO4</i>
7	GPIO 6	LVTTTL digital input/output
8	GPIO 7	LVTTTL digital input/output <i>alt. configuration: complementary LVTTTL output to GPIO6</i>
9	GPIO 8	LVTTTL digital input/output
10	GPIO 9	LVTTTL digital input/output <i>alt. configuration: complementary LVTTTL output to GPIO8</i>
11	GPIO 10	LVTTTL digital inputs/outputs with internal 10 kΩ pull-up
12	GPIO 11	LVTTTL digital inputs/outputs with internal 10 kΩ pull-up <i>alt. configuration: complementary LVTTTL output to GPIO10</i>
13	GND	Reference potential, signal/power ground
14	Reserved	Do not connect
15	Reserved	
16	Reserved	
17	Reserved	
18	Reserved	
19	Reserved	
20	Reserved	
21	Reserved	
22	Reserved	
23	PPS_IN_N	Differential PPS input for time synchronization
24	PPS_IN_P	
25	GND	Reference potential, signal/power ground

3.1.4. SPW1 connector

The connector provides one SpaceWire communication interfaces with standard pinout.

nanoD9 Socket Connector		
PIN #	SIGNAL NAME	DESCRIPTION
1	SPW1_DIN_LVDS_P	Data in, Positive
2	SPW1_SIN_LVDS_P	Strobe in, Positive
3	GND ⁽¹⁾	Reference potential, signal/power ground ⁽¹⁾
4	SPW1_SOUT_LVDS_N	Strobe out, Negative
5	SPW1_DOUT_LVDS_N	Data out, Negative
6	SPW1_DIN_LVDS_N	Data in, Negative
7	SPW1_SIN_LVDS_N	Strobe in, Negative
8	SPW1_SOUT_LVDS_P	Strobe out, Positive
9	SPW1_DOUT_LVDS_P	Data out, Positive

Note 1: Older hardware revisions can have pin 3 not connected or connected to chassis.

3.1.5. SPW2 connector

The connector provides one SpaceWire communication interfaces with standard pinout.

nanoD9 Socket Connector		
PIN #	SIGNAL NAME	DESCRIPTION
1	SPW2_DIN_LVDS_P	Data in, Positive
2	SPW2_SIN_LVDS_P	Strobe in, Positive
3	GND ⁽¹⁾	Reference potential, signal/power ground ⁽¹⁾
4	SPW2_SOUT_LVDS_N	Strobe out, Negative
5	SPW2_DOUT_LVDS_N	Data out, Negative
6	SPW2_DIN_LVDS_N	Data in, Negative
7	SPW2_SIN_LVDS_N	Strobe in, Negative
8	SPW2_SOUT_LVDS_P	Strobe out, Positive
9	SPW2_DOUT_LVDS_P	Data out, Positive

Note 1: Older hardware revisions can have pin 3 not connected or connected to chassis.

3.1.6. PULSE connector

This connector provides the PUS command controlled hardware pulse-commands differential outputs with RS-422 compatible signaling levels.

nanoD25 Socket Connector		
PIN #	SIGNAL NAME	DESCRIPTION
1	PULSE_O_RS422_1_P	Pulse output #1
2	PULSE_O_RS422_1_N	
3	PULSE_O_RS422_2_P	Pulse output #2
4	PULSE_O_RS422_2_N	
5	PULSE_O_RS422_3_P	Pulse output #3
6	PULSE_O_RS422_3_N	
7	PULSE_O_RS422_4_P	Pulse output #4
8	PULSE_O_RS422_4_N	
9	PULSE_O_RS422_5_P	Pulse output #5
10	PULSE_O_RS422_5_N	
11	PULSE_O_RS422_6_P	Pulse output #6
12	PULSE_O_RS422_6_N	
13	GND	Reference potential, signal/power ground
14	PULSE_O_RS422_7_P	Pulse output #7
15	PULSE_O_RS422_7_N	
16	PULSE_O_RS422_8_P	Pulse output #8
17	PULSE_O_RS422_8_N	
18	PULSE_O_RS422_9_P	Pulse output #9
19	PULSE_O_RS422_9_N	
20	PULSE_O_RS422_10_P	Pulse output #10
21	PULSE_O_RS422_10_N	
22	PULSE_O_RS422_11_P	Pulse output #11
23	PULSE_O_RS422_11_N	
24	PULSE_O_RS422_12_P	Pulse output #12
25	PULSE_O_RS422_12_N	

3.1.7. TRX1 connector

This connector provides the RS422-level radio interface. For details about clock and data signaling polarity please see section 3.2.12.

Additionally, one general purpose RS422 interface, UART4 is present. It supports full-duplex operation only (no RS-485 mode is possible).

nanoD25 Socket		
PIN #	SIGNAL NAME	DESCRIPTION
1	TRX1_DOUT_RS422_P	RS422 level baseband data out
2	TRX1_DOUT_RS422_N	
3	TRX1_COUT_RS422_P	RS422 level baseband clock out
4	TRX1_COUT_RS422_N	
5	TRX1_DIN_RS422_P	RS422 level baseband data in
6	TRX1_DIN_RS422_N	
7	TRX1_CIN_RS422_P	RS422 level baseband clock in
8	TRX1_CIN_RS422_N	
9	TRX1_SCAL_IN_RS422_P	RS422 level sub-carrier lock in. Defined as active low.
10	TRX1_SCAL_IN_RS422_N	
11	TRX1_CAL_IN_RS422_P	RS422 level carrier lock in. Defined as active low.
12	TRX1_CAL_IN_RS422_N	
13	GND	Reference potential, signal/power ground
14	GND	
15	GND	
16	GND	
17	GND	
18	GND	
19	GND	
20	UART4_TX_RS422_P	General purpose UART4 transmit
21	UART4_TX_RS422_N	
22	UART4_RX_RS422_P	General purpose UART4 receive
23	UART4_RX_RS422_N	
24	GND	Reference potential, signal/power ground
25	GND	

3.1.8. TRX2 connector

This connector provides the LVDS-level radio interface. For details about clock and data signaling polarity please see section 3.2.12.

Additionally, one general purpose serial interface, UART3 is present. It can be configured in software to use either standard RS-422 signaling levels or LVDS. It supports full-duplex operation only (no RS-485 mode is possible).

nanoD25 Socket		
PIN #	SIGNAL NAME	DESCRIPTION
1	TRX2_DOUT_LVDS_P	Baseband data out, LVDS
2	TRX2_DOUT_LVDS_N	
3	TRX2_COUT_LVDS_P	Baseband clock out, LVDS
4	TRX2_COUT_LVDS_N	
5	TRX2_DIN_LVDS_P	Baseband data in, LVDS
6	TRX2_DIN_LVDS_N	
7	TRX2_CIN_LVDS_P	Baseband clock in, LVDS
8	TRX2_CIN_LVDS_N	
9	TRX2_SCAL_IN_LVDS_P	Sub-carrier lock in, LVDS. Defined as active low
10	TRX2_SCAL_IN_LVDS_N	
11	TRX2_CAL_IN_LVDS_P	Carrier lock in, LVDS. Defined as active low
12	TRX2_CAL_IN_LVDS_N	
13	GND	Reference potential, signal/power ground
14	UART3_TX_LVDS_P	General purpose UART3 transmit, LVDS signaling
15	UART3_TX_LVDS_N	
16	UART3_RX_LVDS_P	General purpose UART3 receive, LVDS signaling
17	UART3_RX_LVDS_N	
18	GND	Reference potential, signal/power ground
19	GND	
20	UART3_TX_RS422_P	General purpose UART3 transmit, RS-422 signaling
21	UART3_TX_RS422_N	
22	UART3_RX_RS422_P	General purpose UART3 receive, RS-422 signaling
23	UART3_RX_RS422_N	
24	TRX2_DETECT	<i>Reserved, do not connect</i>
25	GND	Reference potential, signal/power ground

3.1.9. UMBI connector

This connector is used for sending simulated radio (CCSDS) data through an umbilical connection. For details about clock and data signaling polarity please see section 3.2.12.

nanoD15 Socket		
PIN #	SIGNAL NAME	DESCRIPTION
1	UMBI_DOUT_RS422_P	RS422 level baseband data out
2	UMBI_DOUT_RS422_N	
3	UMBI_COUT_RS422_P	RS422 level baseband clock out
4	UMBI_COUT_RS422_N	
5	UMBI_DIN_RS422_P	RS422 level baseband data in
6	UMBI_DIN_RS422_N	
7	UMBI_CIN_RS422_P	RS422 level baseband clock in
8	UMBI_CIN_RS422_N	
9	UMBI_SCAL_IN_RS422_P	RS422 level sub-carrier lock in; defined as active low
10	UMBI_SCAL_IN_RS422_N	
11	UMBI_CAL_IN_RS422_P	RS422 level carrier lock in; defined as active low
12	UMBI_CAL_IN_RS422_N	
13	UMBI_DETECT	Detects the umbilical connection with an active low signal
14	GND	Reference potential, signal/power ground
15	GND	

3.1.10. DEBUG-SW connector

This connector provides the programming interface for the AAC debugger.

ST60-18P connector		
PIN #	SIGNAL NAME	DESCRIPTION
1	ETH-DEBUG-RESET	Interface to AAC debugger
2	ETH-DEBUG-DETECT	
3	ETH-DEBUG-SYNC	
4	ETH-DEBUG-TX	
5	ETH-DEBUG-RX	
6	ETH-DEBUG-MDC	
7	ETH-DEBUG-MDIO	
8	ETH-DEBUG-CLK	
9	GND	
10	DEBUG-JTAG-TDI	Interface to AAC debugger
11	DEBUG-UART-RX	
12	DEBUG-UART-TX	
13	VCC_3V3	
14	DEBUG-JTAG-TMS	
15	VCC_3V3	
16	DEBUG-JTAG-TDO	
17	GND	
18	DEBUG-JTAG-TCK	

3.1.11. JTAG-RTL connector

This connector provides an interface to program the FPGA during manufacturing.

ST60-10P connector		
PIN #	SIGNAL NAME	DESCRIPTION
1	GND	Interface to Microsemi FlashPro programmer
2	RTL-JTAG-TDI	
3	RTL-JTAG-TRSTB	
4	VCC_3V3	
5	VCC_3V3	
6	RTL-JTAG-TMS	
7	Not connected	
8	RTL-JTAG-TDO	
9	GND	
10	RTL-JTAG-TCK	

3.2. Interface specification and diagrams

3.2.1. Power input

Sirius TCM internal ground and reference voltage for all interface signals are directly connected to ground.

PARAMETER	CONDITIONS/COMMENT	MIN	TYP	MAX	UNIT
INPUT VOLTAGE	between VBUS+ and GND	4.5		16	V
POWER-ON THRESHOLD			4.4		V
UNDERVOLTAGE PROTECTION HYSTERESIS			0.4		V
INPUT POWER	idle ⁽¹⁾ , 4.5 V in idle ⁽¹⁾ , 16 V in		1.5 1.8		W W
GROUND TO CHASSIS POTENTIAL	Note 2	-5	0	+5	V

Note 1: Power consumption is measured during acceptance testing with minimal housekeeping code running and without any connected peripherals. Actual value in specific application depends on the number of interfaces used, connected equipment and system load.

Note 2: Low voltage ground is assumed to nominally be at 0 V w.r.t chassis/structure.

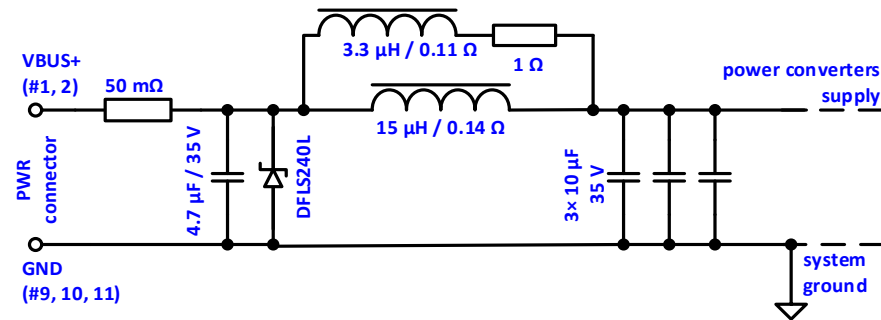


Figure 3.2 shows the inrush current waveform when powered from a Class 0.5 LCL.

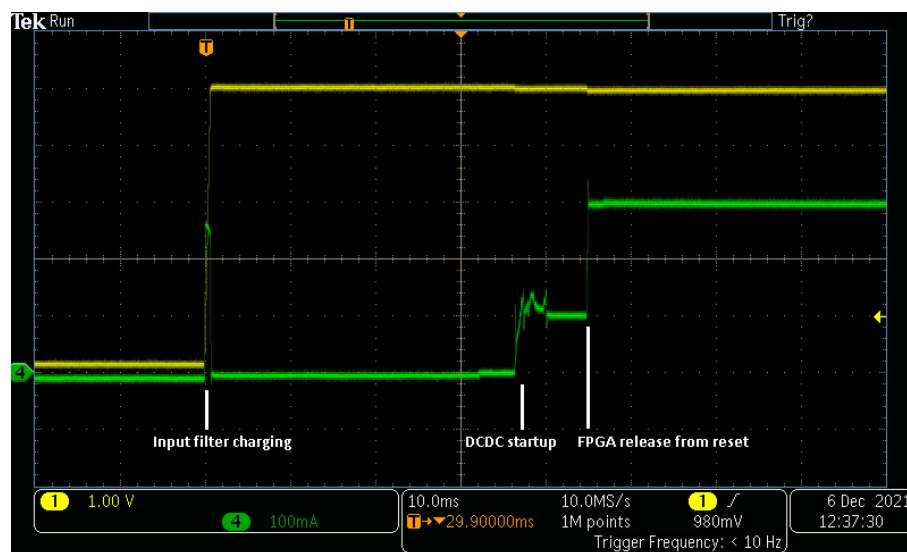


Figure 3.2 Inrush current waveform when powered from Class 0.5 LCL, Yellow=input voltage, Green=input current

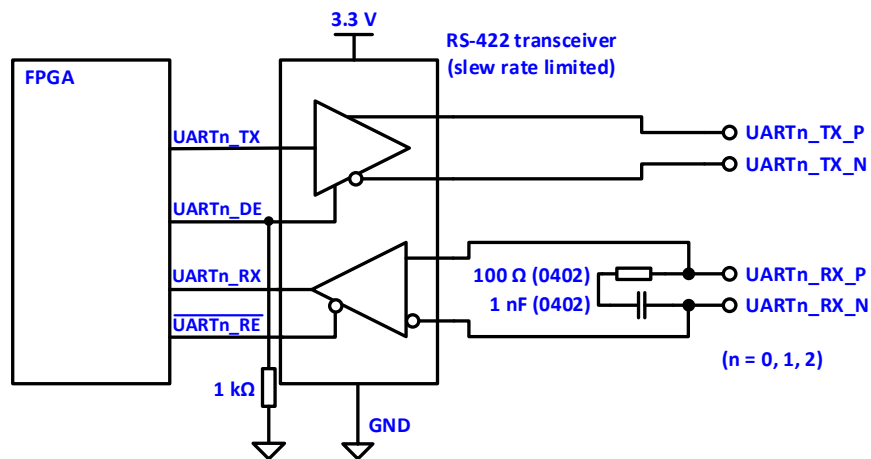
3.2.2. UART0 to UART2 (RS-422/RS-485)

The standard operating mode of UART0 to UART2 interfaces is RS-422, but any of them can be reconfigured in half-duplex RS-485 mode.

PARAMETER	CONDITIONS/COMMENT	MIN	TYP	MAX	UNIT
SIGNALING RATE		1.2		375	kBaud
TX					
DIFFERENTIAL OUTPUT VOLTAGE	100 Ω termination	2.0		3.3	V
	54 Ω termination	1.5		3.3	V
COMMON MODE OUTPUT VOLTAGE	relative to power return		1.65		V
SINGLE-ENDED OUTPUT VOLTAGE	relative to power return	0		3.3	V
OUTPUT RISE/FALL TIME	54 Ω and 50 pF load	0.2		0.8	μ s
TRANSMITTER LOAD	total termination impedance ⁽²⁾	50			Ω
RX					
INPUT DIFFERENTIAL THRESHOLD	between logic 0 and 1	-200	-125	-50	mV
ALLOWED DIFFERENTIAL VOLTAGE		-6		+6	V
ALLOWED INPUT, EACH SINGLE PIN	relative to power return	-7		+12	V

Note 1: Logic 1 signal is defined as pin “_P” positive relative to respective pin “_N”. Open or short circuit on receiver pins results in logic 1 being detected.

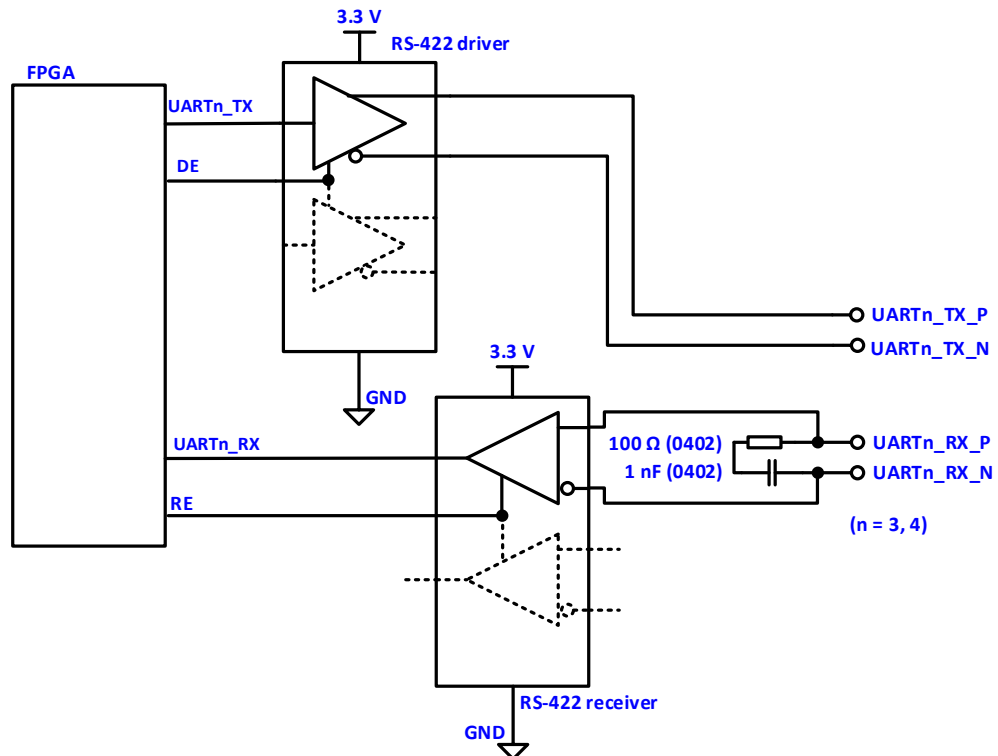
Note 2: When used in RS485 mode, the internal AC termination needs to be taken into when computing total terminator load.



3.2.3. UART3 and UART4 (RS-422)

PARAMETER	CONDITIONS/COMMENT	MIN	TYP	MAX	UNIT
DATA RATE		1.2		375	kBaud
TX					
DIFFERENTIAL OUTPUT VOLTAGE	100 Ω termination resistance	2.0	2.6	3.3	V
COMMON MODE OUTPUT VOLTAGE	100 Ω termination resistance		1.5	2.0	V
SINGLE-ENDED OUTPUT VOLTAGE	relative to power return	0		3.3	V
OUTPUT RISE/FALL TIME	100 Ω and 60 pF load		5	10	ns
TRANSMITTER LOAD	total termination impedance	100			Ω
RX					
INPUT DIFFERENTIAL THRESHOLD	between logic 0 and 1	-200		+200	mV
ALLOWED DIFFERENTIAL VOLTAGE		-7		+7	V
COMMON MODE VOLTAGE	relative to power return	-7		+7	V

Note 1: Logic 1 signal is defined as pin “_P” positive relative to respective pin “_N”. Open or short circuit on receiver pins results in logic 1 being detected



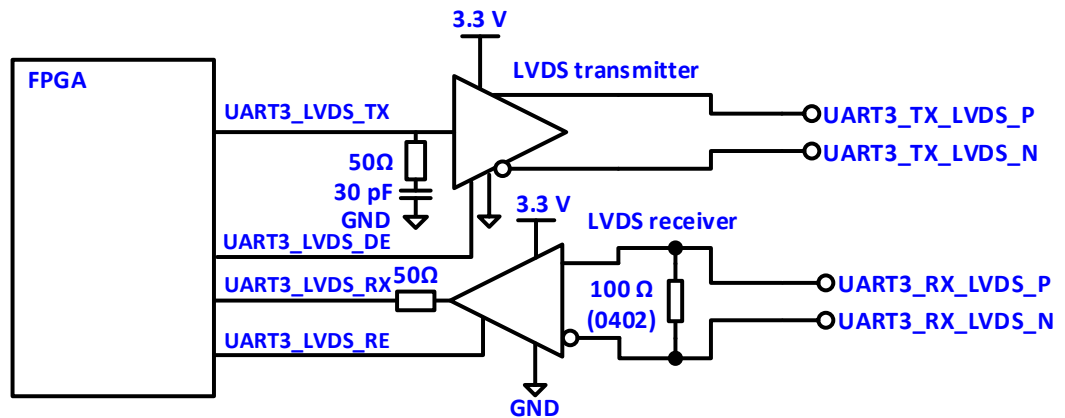
3.2.4. UART3 (LVDS mode)

PARAMETER	CONDITIONS/COMMENT	MIN	TYP	MAX	UNIT
DATA RATE		1.2		375 ⁽²⁾	kBaud
TX					
DIFFERENTIAL OUTPUT VOLTAGE	100 Ω termination	250	350	450	mV
COMMON MODE OUTPUT VOLTAGE	100 Ω load, relative to GND		1.25		V
SINGLE-ENDED OUTPUT VOLTAGE	100 Ω load, relative to GND	0.9		1.6	V
OUTPUT RISE/FALL TIME	100 Ω and 10 pF load		0.4	1.5	ns
SHORT-CIRCUIT OUTPUT CURRENT				9	mA
REQUIRED TERMINATION	external resistor	90		130	Ω
RX					
INPUT DIFFERENTIAL THRESHOLD	between logic 0 and 1	-100	± 20	+100	mV
NOMINAL COMMON MODE VOLTAGE	for 200 mV differential ⁽³⁾	0.1		2.3	V
ALLOWED DIFFERENTIAL VOLTAGE		-1.5		+1.5	V
ALLOWED INPUT VOLTAGE	single-ended, relative to system GND	0		3.0	V

Note 1: Logic 1 signal is defined as pin “_P” positive relative to respective pin “_N”. Open or short circuit on receiver pins results in logic 1 being detected

Note 2: Limited by current software/firmware capabilities.

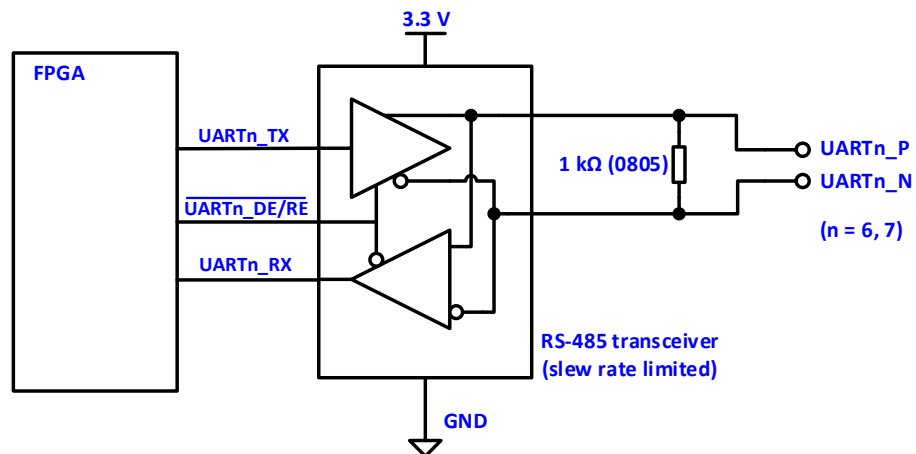
Note 3: For higher differential voltage, narrow the range by $V_{ID}/2$ at each end.



3.2.5. UART6 and UART7 (RS-485)

PARAMETER	CONDITIONS/COMMENT	MIN	TYP	MAX	UNIT
SIGNALING RATE		1.2		375	kBaud
DIFFERENTIAL OUTPUT VOLTAGE	100 Ω termination	2.0		3.3	V
	54 Ω termination	1.5		3.3	V
COMMON MODE OUTPUT VOLTAGE	relative to power return		1.65		V
SINGLE-ENDED OUTPUT VOLTAGE	relative to power return	0		3.3	V
OUTPUT RISE/FALL TIME	54 Ω and 50 pF load	0.2		0.8	μ s
TRANSMITTER LOAD	total termination impedance	50			Ω
INPUT DIFFERENTIAL THRESHOLD	between logic 0 and 1	-200	-125	-50	mV
ALLOWED INPUT DIFFERENTIAL VOLTAGE		-6		+6	V
ALLOWED VOLTAGE, EACH SINGLE PIN	relative to power return	-7		+12	V

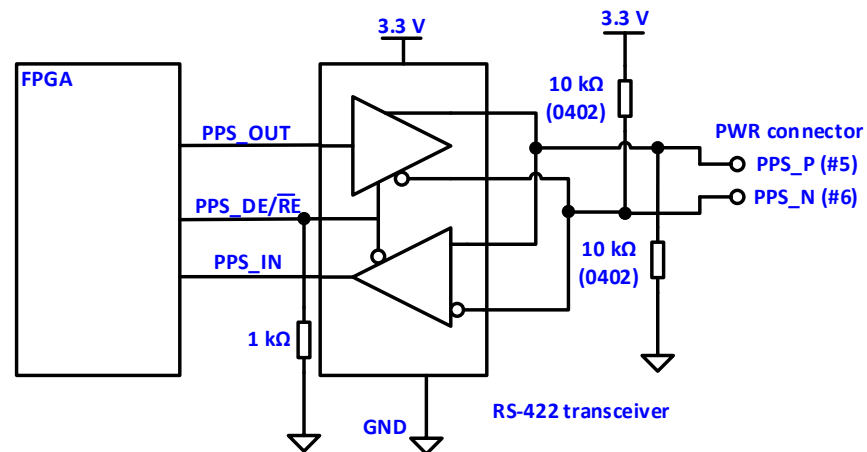
Note 1: Logic 1 signal is defined as pin “_P” positive relative to respective pin “_N”. In RX mode, an open or short circuit condition results in logic 1 being detected.



3.2.6. PPS transceiver

PARAMETER	CONDITIONS/COMMENT	MIN	TYP	MAX	UNIT
DIFFERENTIAL OUTPUT VOLTAGE	100 Ω termination	2.0		3.3	V
	54 Ω termination	1.5		3.3	
COMMON MODE OUTPUT VOLTAGE	relative to power return		1.65		V
SINGLE-ENDED OUTPUT VOLTAGE	relative to power return	0		3.3	V
OUTPUT RISE/FALL TIME	54 Ω and 50 pF load			15	ns
TRANSMITTER LOAD	external termination impedance	50			Ω
PULSE DETECTION DIFFERENTIAL THRESHOLD		-200	-125	-50	mV
ALLOWED INPUT DIFFERENTIAL VOLTAGE		-6		+6	V
ALLOWED VOLTAGE, EACH SINGLE PIN	relative to power return	-7		+12	V
INPUT PPS PULSE LENGTH	required for accepted PPS	1		1000	μ s

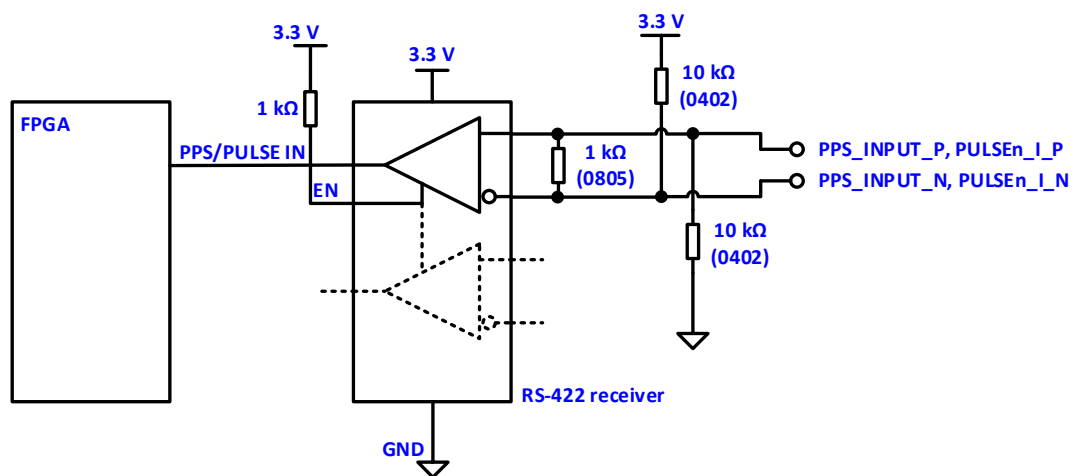
Note 1: Pulse is active when pin "PPS_P" is positive relative to pin "PPS_N"



3.2.7. PPS input and pulse command input

PARAMETER	CONDITIONS/COMMENT	MIN	TYP	MAX	UNIT
PULSE DETECTION DIFFERENTIAL THRESHOLD		-200		+200	mV
ALLOWED INPUT DIFFERENTIAL VOLTAGE		-7		+7	V
ALLOWED VOLTAGE, EACH SINGLE PIN	relative to power return	-7		+7	V
VALID PULSE DURATION	PULSE0 and PULSE1	20		40	ms
	PPS input	1		1000	µs

Note 1: Pulse is detected as active when pin “_P” is positive relative to respective pin “_N”.

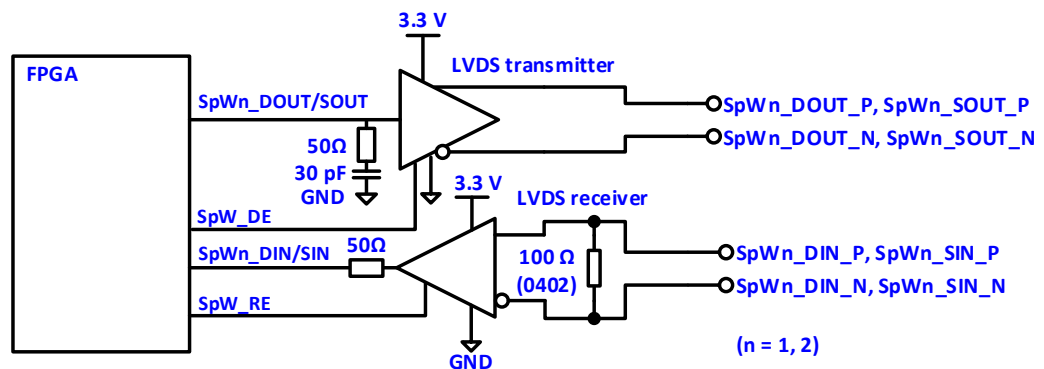


3.2.8. SpaceWire interfaces

PARAMETER	CONDITIONS/COMMENT	MIN	TYP	MAX	UNIT
DATA RATE	After handshake ⁽¹⁾		50		Mbit
TX					
DIFFERENTIAL OUTPUT VOLTAGE	100 Ω load	250	350	450	mV
COMMON MODE OUTPUT VOLTAGE	100 Ω load, relative to GND		1.25		V
SINGLE-ENDED OUTPUT VOLTAGE	100 Ω load, relative to GND	0.9		1.6	V
OUTPUT RISE/FALL TIME	100 Ω and 10 pF load		0.4	1.5	ns
SHORT-CIRCUIT OUTPUT CURRENT				9	mA
REQUIRED TERMINATION	external resistor	90		130	Ω
RX					
INPUT DIFFERENTIAL THRESHOLD	between logic 0 and 1	-100	± 20	+100	mV
NOMINAL COMMON MODE VOLTAGE	for 200 mV differential ⁽²⁾	0.1		2.3	V
ALLOWED DIFFERENTIAL VOLTAGE		-1.5		+1.5	V
ALLOWED INPUT VOLTAGE	single-ended, relative to system GND	0		3.0	V

Note 1: Handshake is performed at 10 Mbit, only 50 Mbit is supported elsewhere

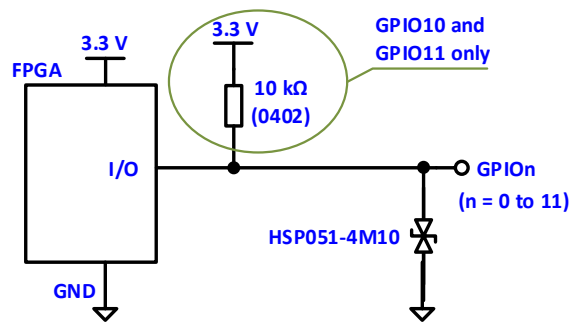
Note 2: For higher differential voltage, narrow the range by $V_{ID}/2$ at each end.



3.2.9. GPIO interface

PARAMETER	CONDITIONS/COMMENT	MIN	TYP	MAX	UNIT
OUTPUT					
OUTPUT VOLTAGE, LOW	sinking ≤ 12 mA	0		0.4	V
OUTPUT VOLTAGE, HIGH	sourcing ≤ 12 mA	2.4		3.3	V
OUTPUT CURRENT	do not exceed this value	-12		+12	mA
INPUT					
LOGIC LOW		0		0.8	V
LOGIC HIGH		2.0		3.3	V

Note 1: All voltages are relative to system GND (power return potential).

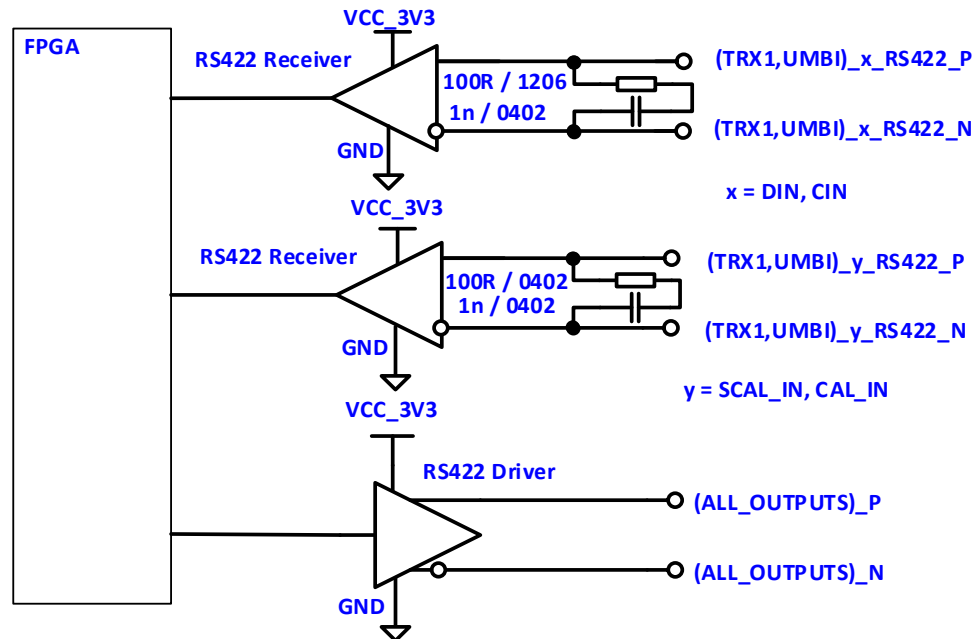


3.2.10. TRX1 and UMBI Interface (RS-422)

PARAMETER	CONDITIONS/COMMENT	MIN	TYP	MAX	UNIT
TX					
DIFFERENTIAL OUTPUT VOLTAGE	100 Ω termination resistance	2.0	2.6	3.3	V
COMMON MODE OUTPUT VOLTAGE	100 Ω termination resistance		1.5	2.0	V
SINGLE-ENDED OUTPUT VOLTAGE	relative to power return	0		3.3	V
OUTPUT RISE/FALL TIME	100 Ω and 60 pF load		5	10	ns
TRANSMITTER LOAD	total termination impedance	100			Ω
RX					
INPUT DIFFERENTIAL THRESHOLD	between logic 0 and 1	-200		+200	mV
ALLOWED DIFFERENTIAL VOLTAGE		-7		+7	V
COMMON MODE VOLTAGE	relative to power return	-7		+7	V
ALLOWED TERMINATION DISSIPATION ²	DIN and CIN			125	mW
ALLOWED TERMINATION DISSIPATION ²	SCAL and CAL			30	mW

Note 1: Logic 1 signal is defined as pin “_P” positive relative to respective pin “_N”. Open or short circuit on receiver pins results in logic 1 being detected

Note 2: Dissipation in termination resistor is calculated through $P = C \cdot V^2 \cdot f$

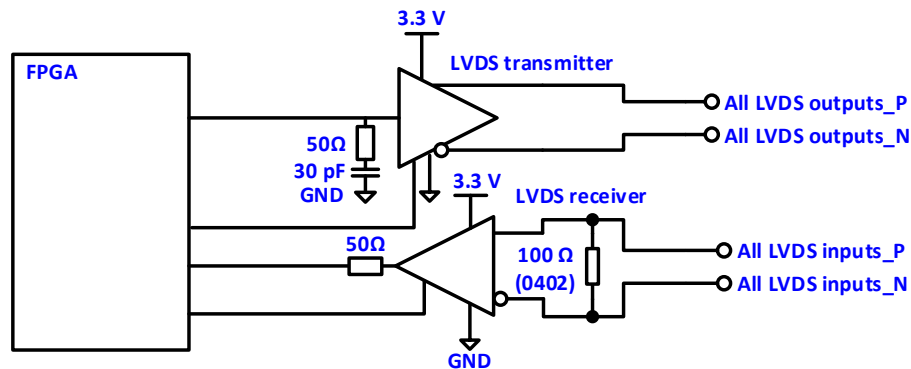


3.2.11. TRX2 Interface (LVDS)

PARAMETER	CONDITIONS/COMMENT	MIN	TYP	MAX	UNIT
TX					
DIFFERENTIAL OUTPUT VOLTAGE	100 Ω termination	250	350	450	mV
COMMON MODE OUTPUT VOLTAGE	100 Ω load, relative to GND		1.25		V
SINGLE-ENDED OUTPUT VOLTAGE	100 Ω load, relative to GND	0.9		1.6	V
OUTPUT RISE/FALL TIME	100 Ω and 10 pF load		0.4	1.5	ns
SHORT-CIRCUIT OUTPUT CURRENT				9	mA
REQUIRED TERMINATION	external resistor	90		130	Ω
RX					
INPUT DIFFERENTIAL THRESHOLD	between logic 0 and 1	-100	± 20	+100	mV
NOMINAL COMMON MODE VOLTAGE	for 200 mV differential ⁽²⁾	0.1		2.3	V
ALLOWED DIFFERENTIAL VOLTAGE		-1.75		+1.75	V
ALLOWED INPUT VOLTAGE	single-ended, relative to system GND	0		3.0	V

Note 1: Logic 1 signal is defined as pin “_P” positive relative to respective pin “_N”. Open or short circuit on receiver pins results in logic 1 being detected.

Note 2: For higher differential voltage, narrow the range by $V_{ID}/2$ at each end.



3.2.12. TM/TC Interface timing

3.2.12.1. TM interface

Figure 3.3 details the output timing between the clock (COUT) and data (DOUT) on the TM interface. Depending on the radio used and how that samples data, the harness needs to be adjusted to match. I.e. for a radio that samples data on the **falling edge** of the clock input (COUT) the default harness configuration can be used (TCM_COUT_P <-> RADIO_CIN_P, TCM_COUT_N <-> RADIO_CIN_N). However, if the radio samples the data on the **rising edge**, the TM_COUT P and N signals needs to be switched in the connection between the radio and the TCM (TCM_COUT_N <-> RADIO_CIN_P, TCM_COUT_P <-> RADIO_CIN_N).

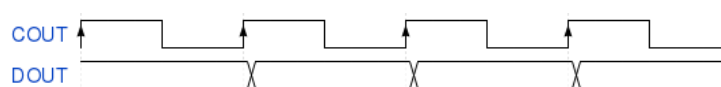


Figure 3.3 TM default clock and data timing diagram

3.2.12.2. TC interface

Figure 3.4 details the expected input timing between the clock (CIN) and data (DIN) together with the subcarrier lock signal (SCAL_IN) on the TC interface. Just as for the TM interface, different radios might change the data on different clock flanks. As the TCM TC interface samples data on the **rising edge** of the clock (CIN), P and N signals might need switching here as well. The setup and hold times should be at least 1/4th clock cycle each. When the subcarrier lock signal (SCAL_IN) is high, any data on the TC interface will be ignored.

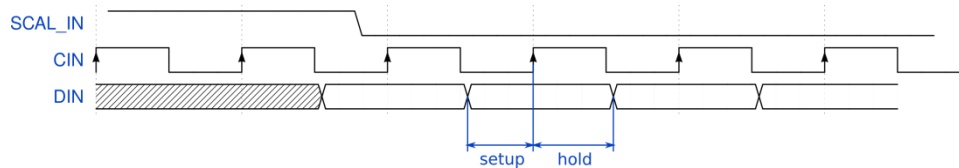
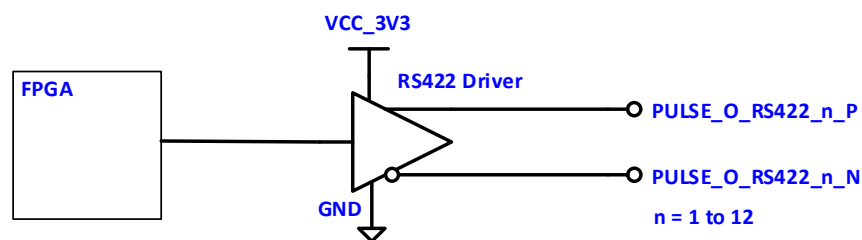


Figure 3.4 TC default clock, data and subcarrier lock timing diagram

3.2.13. Pulse output (RS-422)

PARAMETER	CONDITIONS/COMMENT	MIN	TYP	MAX	UNIT
DIFFERENTIAL OUTPUT VOLTAGE	100 Ω termination resistance	2.0	2.6	3.3	V
COMMON MODE OUTPUT VOLTAGE	relative to power return		1.5	2.0	V
SINGLE-ENDED OUTPUT VOLTAGE	relative to power return	0		3.3	V
OUTPUT RISE/FALL TIME	100 Ω and 60 pF load		5	10	ns
TRANSMITTER LOAD	total termination resistance	100			Ω

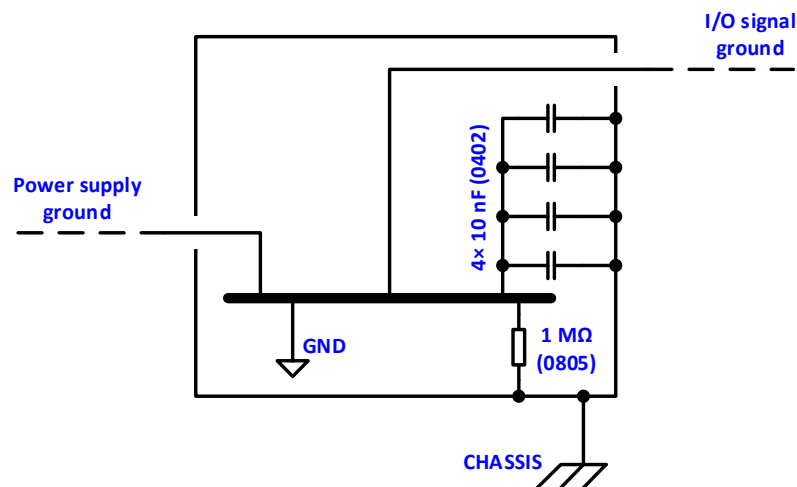
Note 1: Logic 1 signal is defined as pin “_P” positive relative to respective pin “_N”.



3.3. Grounding

Sirius TCM internal power supply converters are not isolated, and the internal unit ground is therefore galvanically connected to power supply return potential. This ground potential forms a reference voltage for all unit electrical interfaces.

Chassis is connected to the internal ground mainly capacitively with a high impedance bleed resistor. Please note that older hardware revisions may have a capacitance of 4x1nF.



When assembled in the spacecraft, the chassis shall be bonded to the spacecraft structure. This is accomplished either through using the grounding point on the case, or through ensuring a low impedance surface-to-surface contact between DHS and spacecraft structure. The grounding point is an M3 threaded hole. If several Sirius units are assembled in a stack configuration, it is sufficient to use only one of the grounding points as the enclosures are electrically connected through mechanical interlocks.



3.4. Fault voltage emission

The worst fault voltage which can be emitted from TCM on any interface is the incoming supply voltage.

3.5. Frequency plan

The frequencies in use for the different interfaces are given in the table below.

Principal frequency [MHz]	Use / Description	Source
100.0	Main system clock	MEMS oscillator
100.0	SDRAM, single data-rate	MEMS oscillator, FPGA
50.0	CPU clock	MEMS oscillator, divided down in FPGA
50.0	SpaceWire #1 and #2, link connected	MEMS oscillator, divided down in FPGA
25.0	System flash data interface	MEMS oscillator, divided down in FPGA
12.5	NVRAM, internal SPI bus	MEMS oscillator, software-configurable division in FPGA
12.5	ADC internal SPI bus	MEMS oscillator, software-configurable division in FPGA
10.0	SpaceWire #1 and #2, link disconnected	MEMS oscillator, divided down in FPGA
8.1 to 0.1	TM (radio TX)	MEMS oscillator, divided down in FPGA
3.125	NVRAM, internal SPI bus during boot	MEMS oscillator, divided down in FPGA
0.50 ± 0.12	3.3V DC-DC converter	asynchronous, free running RC-oscillator
0.29 ± 0.07	1.2V DC-DC converter	asynchronous, free running RC-oscillator
≤ 0.375	UART0 to UART7	MEMS oscillator, software-configurable division in FPGA
0.115	debug UART	MEMS oscillator, divided down in FPGA
0.01	ADC inputs sampling rate	MEMS oscillator, software-configurable division in FPGA